

Product Overview

This chapter contains the following information:

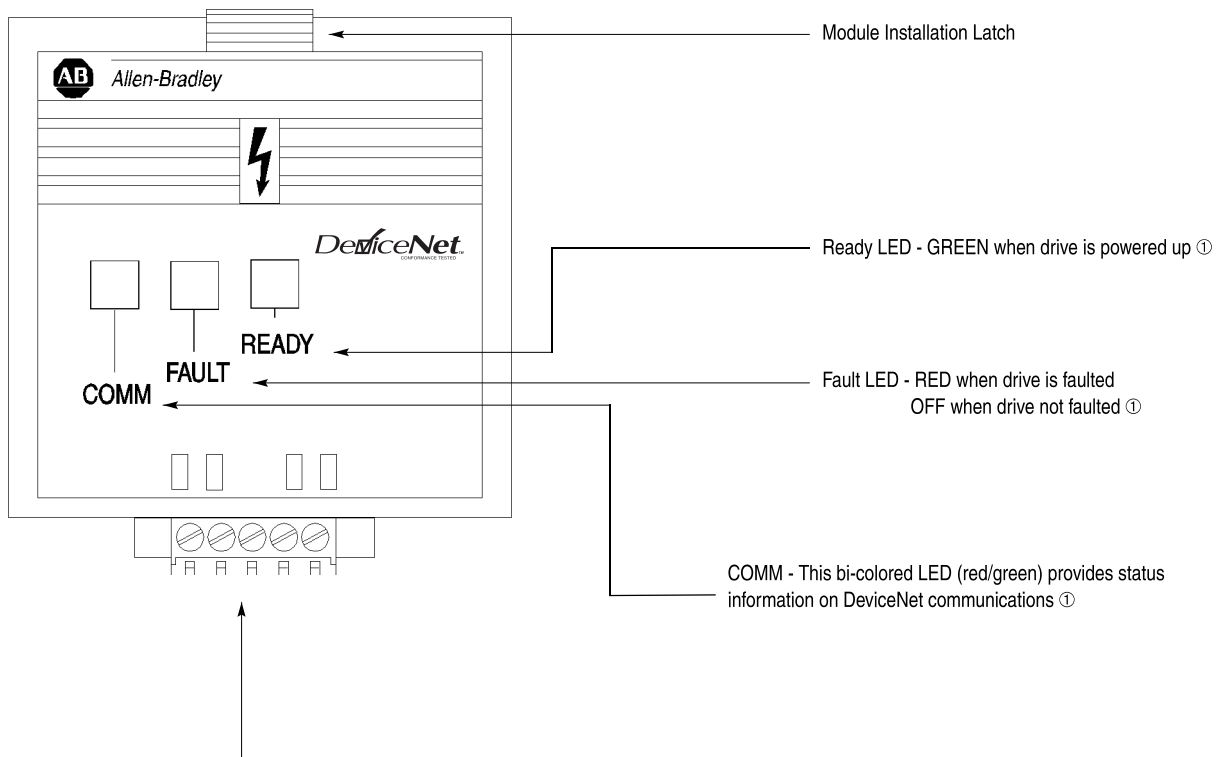
- physical layout of the module
- location of configuration switches
- DeviceNet overview and components

Module Description

The Bulletin 160 SSC DeviceNet Communication Module is an optional interface device designed to provide a direct, digital link between DeviceNet devices and the Bulletin 160 SSC drive. The module connects to the Bulletin 160 SSC through the expansion/keypad port on the front of the drive.

LEDs and DeviceNet Connection

Figure 1.1
Module Front View



DeviceNet Terminal Block Plug - The Communication Module receives power and communications through this connector.

① See [Chapter 4, Modes of Operation](#), and [Chapter 7, Troubleshooting](#), for detailed operation.

DIP Switches

Figure 1.2
Module Rear View

The Communication Module has one eight position DIP switch for setting the DeviceNet Node Address and Baud Rate. DIP switches are located on the rear of the module and are only accessible when the module is removed from the Bulletin 160 SSC drive.

